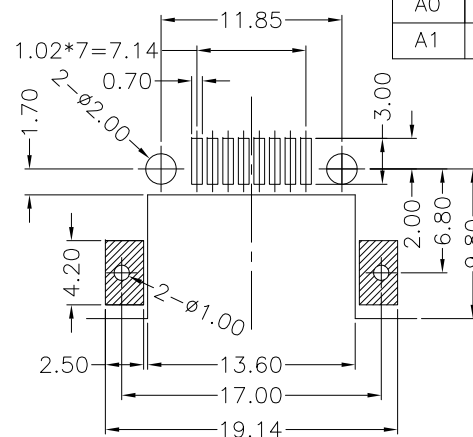
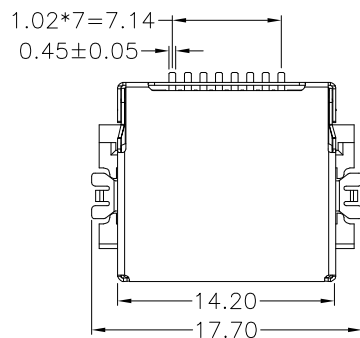
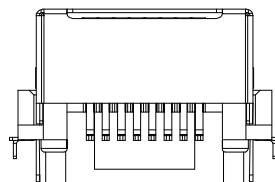
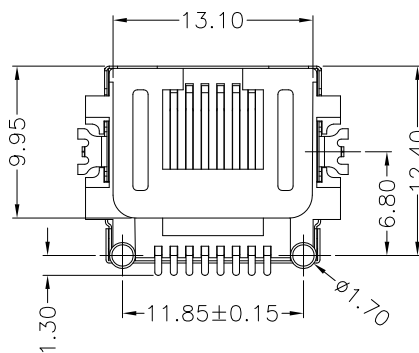
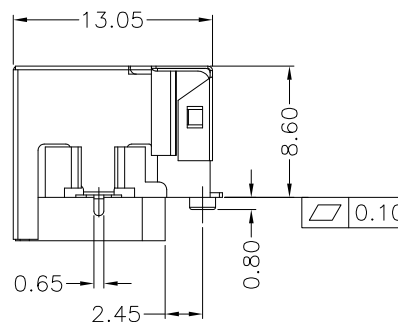
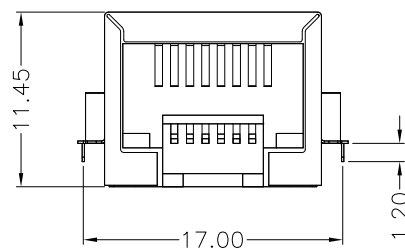


GP Component

REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	DESIGN
A0			Initial	2016/04/11	Phebe Su
A1			Change housing type	2016/04/28	Phebe Su



RECOMMEND PCB LAYOUT (TOP VIEW)
DIMENSIONAL TOLERANCE: ± 0.05



NOTES:

- MATERIALS:
HOUSING: LCP, BLACK UL94V-0,
CONTACTS: PHOSPHOR BRONZE T=0.30
G/F ON CONTACT AREA
SHIELD: COPPER ALLOY,
30u" NICKEL PLATING OVERALL
- OPERATING TEMPERATURE: $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$
- JACK CAVITY CONFORMS TO FCC RULES
AND REGULATIONS PART 68, SUBPART F

ORDER INFORMATION :

Matrix-RJ45
F : 10/100
G : 10/100/1000
N : Pure Connector
11:1X1 ; 21:2X1
12:1X2 ; 22:2X2
14:1X4 ; 24:2X4
16:1X6 ; 26:2X6
18:1X8 ; 28:2X8
1U:RJ+USB

MRJN-11S470TRS
RS: ROHS
HF: Halogen Free
Industrial Temperature
Series Number
S: SMD
T: THT

NO	VARIETY	QTY	MATERIAL	REMARK
 Matrix Electronics Co.,Ltd				
TOLERANCE: X:X ±0.38 X:XX ±0.25 X:XXX ±0.13 ANGLE: $\pm 3^{\circ}$		DESIGN BY : Phebe Su	DATE : 2016/04/28	PART NAME: RJ45 1X1 PCB JACK W/O LED SMT TYPE
UNIT: mm [inch]		CHECKED BY: Vicky Hsieh	DATE : 2016/04/28	PART NO. MRJN-11S470TRS
SCALE:1:1 SIZE:A4		APPROVED BY1: Richard Hsieh	DATE : 2016/04/28	MOLD NO. NA
		APPROVED BY2: Richard Hsieh	DATE : 2016/04/28	DRAW NO.
				SHEET NO. 1 OF 1